

TAI-SAW TECHNOLOGY CO., LTD. No. 3, Industrial 2nd Rd., Ping-Chen Industrial District, Taowian 324. Taiwan, R.O.C.

TEL: 886-3-4690038 FAX: 886-3-4697532 E-mail: tstsales@mail.taisaw.com Web: www.taisaw.com

Product Specifications Approval Sheet

Product Description	: Crystal Unit SMD 3.2	2x2.5 8.00MHz
TST Part No.: TZ33	13B	
Customer Part No.:_		
Customer signature	required	
Company:		
Division:		
Approved by :		
Date:		
Checked by:	Chia Haur Rau	CH
Approved by:	Kelly Huang	Kaly Juang
Date:	09/11/2018	7

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 8.00MHz

MODEL NO.: TZ3313B REV. NO.: 1

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
Rev. 1	Rev. Page N/A	Rev. Account Initial release	Date 09/11/18'	Ref. No.	Revised by Chia Haur Rau

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 8.00MHz

MODEL NO.: TZ3313B REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL): Level-1



Description and Applications:

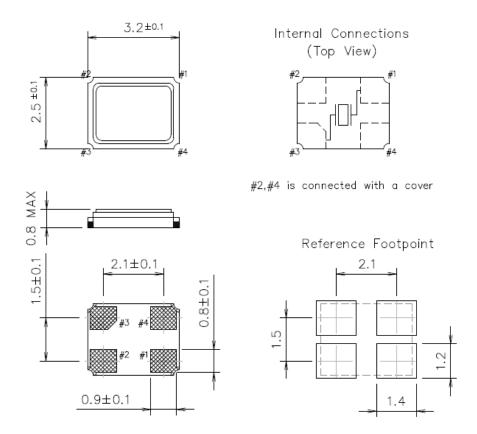
Surface mount 3.2mmx2.5mm crystal unit for customer for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

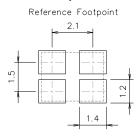
TZ3313B	Specification
Nominal Frequency	8.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +85°C
Operating Temperature Range	-40°C to +85°C
Frequency Stability over Operating Temperature	+/- 30 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/- 10 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	500 $Ω$ max.
Nominal Drive Level	10uW typical and 100uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	8 pF
Aging	+/-2ppm/year
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g

Mechanical Dimensions (mm):

Base



Recommended Land Pattern: (unit: mm)

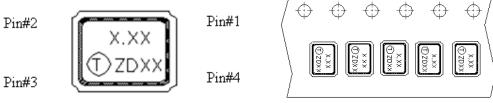


Marking:

Line 1: Frequency (8.00)

Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code (1 or 2 letters,

underline or no underline)



The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

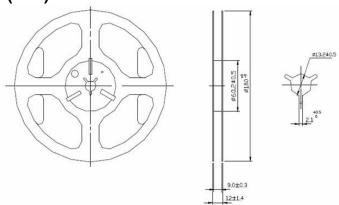
Product Code Table

	2013	2014	2015	2016
Year	2017	2018	2019	2020
	2021	2022	2023	2024
product code	Z	Z	<u>Z</u>	<u>Z</u>

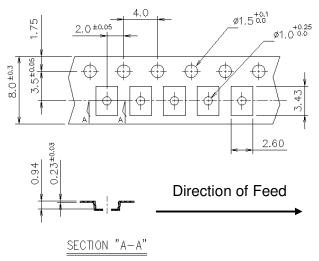
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	Е	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	s	t	u	V	w	х	у	z

Reel Dimensions (mm):



Tape Dimensions (mm):



[NOTE]

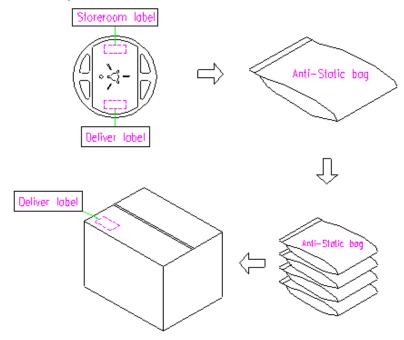
- 1 UNIT : mm.
- 2 UNLESS OTHERWISE SPECIFIED TOLERANCEON DIM. +/-0.1mm.
- 3 MATERIAL: CONDUCTIVE POLYSTYRENE.
- 4 COLOR: BLACK.
- 5 10 PITCHES CUMULATIVETOLERANCE +/-0.2mm.

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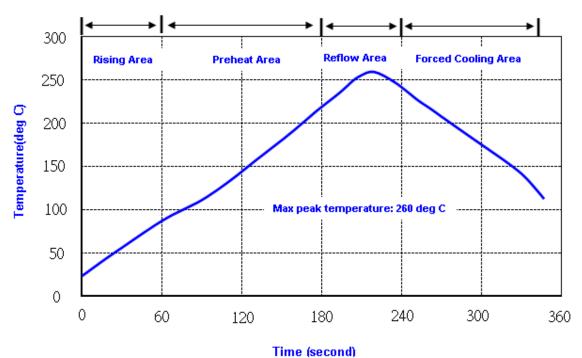
TST DCCRelease document

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	* 1						
Mechanical characteristics							
resistance to Soldering heat (IR reflow)	Temp / Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)					
Vibration	Total peak amplitude: 1.5mm Vibration frequency: 10 to 2000 Hz Sweep period: 20 minute Vibration directions: 3 mutually perpendicular Duration: 2 hr/direc.	MIL-STD 202G method 204					
Mechanical Shock	directions: 3 impacts per axis Acceleration: 3000g's, +20/-0% Duration: 0.3 ms (total 18 shocks) Waveform: Half-sine	MIL-STD 202G method 213					
Solderability	Solder Temperature:265±5 ℃ Duration time: 5±0.5 seconds.	J-STD-002					
Environmental							
Thermal Shock	Heat cycle conditions -40 $^{\circ}$ C (30min) \longleftrightarrow 85 $^{\circ}$ C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8					
Humidity test	Temperature : $85 \pm 2 ^{\circ}$ C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103					
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A					
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 °C Duration : 96 hours	IEC 60068-2-1					